

International IOR Rectifier

IRFK4H350, IRFK4J350

Isolated Base Power HEX-pak™ Assembly - Parallel Chip Configuration

- High Current Capability.
- UL recognised E78996.
- Electrically Isolated Base Plate.
- Easy Assembly into Equipment.



Description

The HEX-pak™ utilises the well-proven HEXFET™ die, combining low on-state resistance with high transconductance. These superior technology die are assembled by state of the art techniques into the TO-240 package, featuring 2.5kV rms isolation and solid M5 screw connections. The small footprint means the package is highly suited to power applications where space is a premium. Available in two versions, IRFK.H... for fast switching and IRFK.J... for oscillation sensitive applications.

$$V_{DS} = 400V$$

$$R_{DS(on)} = 75m\Omega$$

$$I_D = 50A$$

Absolute Maximum Rating

	Parameter	Max.	Units
I_D @ $T_C=25^\circ C$	Continuous Drain Current	50	A
I_D @ $T_C=100^\circ C$	Continuous Drain Current	32	A
I_{DM}	Pulse Drain Current	200	A ①
P_D @ $T_C=25^\circ C$	Maximum Power Dissipation	500	W
V_{GS}	Gate-to-Source Voltage	20	V
V_{INS}	R.M.S. Isolation Voltage, circuit to base	2.5	kV
T_J	Operating Junction Temperature Range	-40 to 150	$^\circ C$
T_{STG}	Storage Temperature Range	-40 to 150	$^\circ C$

Thermal and Mechanical Specifications

	Parameter	Min.	Typ.	Max.	Units
R_{thJC}	Junction-to-Case	-	-	0.25	K/W ②
R_{thCS}	Case-to-Sink, smooth & greased surface	-	0.1	-	K/W
T	Mounting Torque +10%				③
	HEXpak to Heatsink	-	5	-	Nm
	Busbar to HEXpak	-	3	-	Nm
wt	Approximate Weight	-	140	-	g
		-	5	-	oz

Notes:

① - Repetitive Rating: Pulse width limited by maximum junction temperature see figure 8.

② - Per Module.

③ - A mounting compound is recommended and the torque should be rechecked after a period of three hours to allow for the spread of the compound.

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Electrical Characteristics @ $T_J = 25^{\circ}\text{C}$ (Unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
$B_{V_{DS}}$	Drain-to-Source Breakdown voltage	400	-	-	V	$V_{GS}=0V, I_D=1.0mA$
$R_{DS(on)}$	Static Drain-to-Source On-State Resistance	-	63	75	m Ω	$V_{GS}=10V, I_D=16A$
$I_{D(on)}$	On-State Drain Current	50	-	-	A	$V_{DS} > I_{D(on)} \times R_{DS(on)max}, V_{GS}=10V$
$V_{GS(th)}$	Gate Threshold Voltage	2.0	-	4.0	V	$V_{DS}=V_{GS}, I_D=1.0mA$
g_{fs}	Forward Transconductance ④	32	50	-	S	$V_{DS} > 50V, I_D=32A$
I_{DSS}	Zero Gate Voltage Drain Current	-	-	1.0	mA	$V_{DS}=V_{DSmax}, V_{GS}=0V$
		-	-	4.0	mA	$V_{GS}=10V, T_C=125^{\circ}\text{C}, V_{DS}=V_{DSmax} \times 0.8$
I_{GSS}	Gate-to-Source Leakage Forward	-	-	400	nA	$V_{GS}=20V$
I_{GSS}	Gate-to-Source Leakage Reverse	-	-	-400	nA	$V_{GS}=-20V$
Q_g	Total Gate Charge	-	400	550	nC	$I_D=50A, V_{GS}=10V,$
Q_{gs}	Gate-to-Source Charge	-	60	80	nC	$V_{DS}=V_{DSmax} \times 0.8$
Q_{gd}	Gate-to-Drain ("Miller") Charge	-	175	250	nC	
$t_{d(on)}$	Turn-on Delay Time	IRFK4H350	-	50	-	$V_{DD}=180V, I_D=32A,$ $V_{GS}=10V,$ $R_{SOURCE}=3.3\Omega$
		IRFK4J350	-	60	-	
t_r	Rise Time	IRFK4H350	-	55	-	
		IRFK4J350	-	70	-	
$t_{d(off)}$	Turn-off Delay Time	IRFK4H350	-	230	-	
		IRFK4J350	-	300	-	
t_f	Fall Time	IRFK4H350	-	50	-	
		IRFK4J350	-	70	-	
L_{DS}	Drain-to-Source Inductance	-	18	-	nH	
C_{iss}	Input Capacitance	-	17.5	-	nF	$V_{GS}=0V, V_{DS}=25V,$ $f=1.0MHz$
C_{oss}	Output Capacitance	-	11.2	-	nF	
C_{rss}	Reverse Transfer Capacitance	-	8.0	-	nF	
	Linear Derating Factor	-	-	4	W/K	

Source-Drain Diode Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
I_S	Continuous Source Current (Body Diode)	-	-	50	A	
I_{SM}	Pulsed Source Current (Body Diode)	-	-	190	A	
V_{SD}	Diode Forward Voltage	-	-	1.6	V	$V_{GS}=0V, I_S=50A, T_C=25^{\circ}\text{C}$
t_{rr}	Reverse Recovery Time	180	400	880	ns	$di/dt=400A/\mu s, T_J=150^{\circ}\text{C}$
Q_{rr}	Reverse Recovered Charge	8.0	20.0	52.0	μC	$I_S=50A$

Notes:

④ - Pulse Width $\leq 300\mu s$; Duty cycle $\leq 2\%$.



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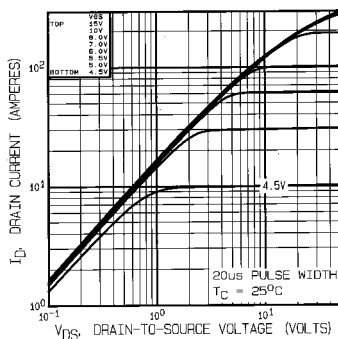


Fig 1. Typical Output Characteristics,
 $T_C = 25^\circ\text{C}$

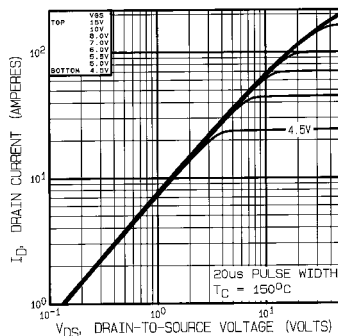


Fig 2. Typical Output Characteristics,
 $T_C = 150^\circ\text{C}$

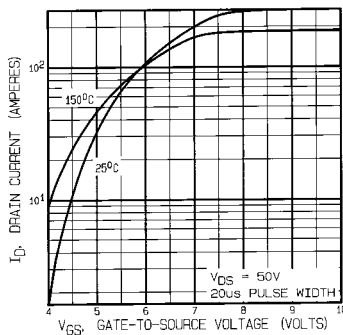


Fig 3. Typical Transfer Characteristics

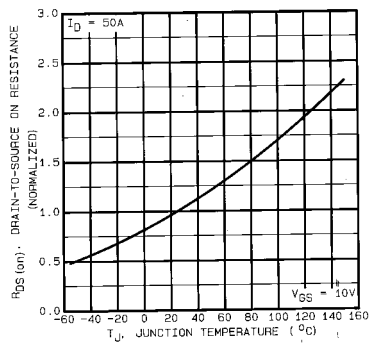
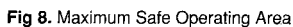
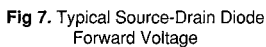


Fig 4. Normalized On-Resistance Vs.
Temperature



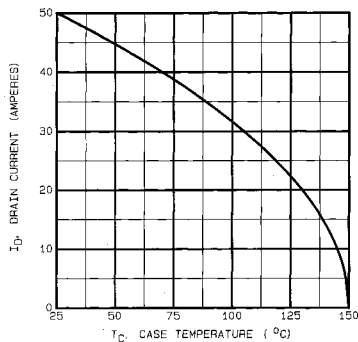


Fig 9. Maximum Drain Current Vs. Case Temperature

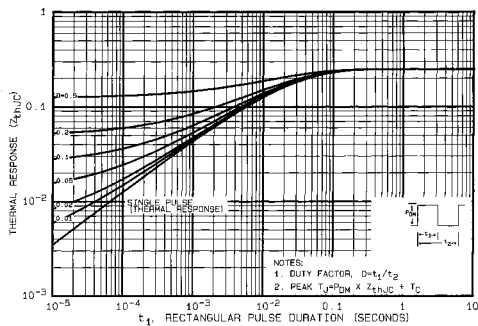


Fig 10. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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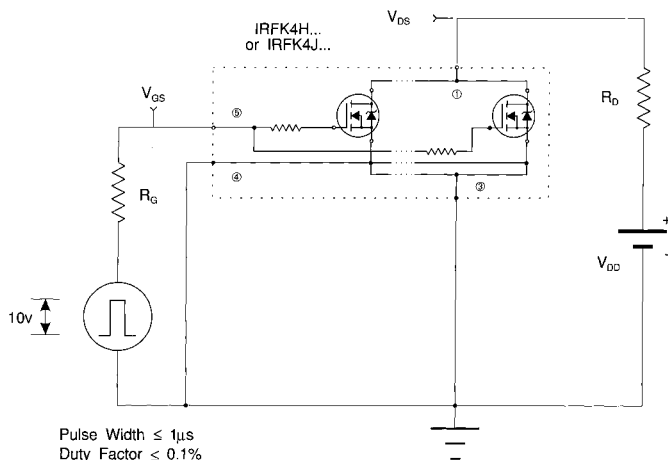


Fig 11a. Switching Time Test Circuit

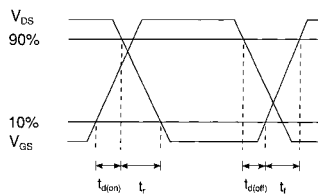
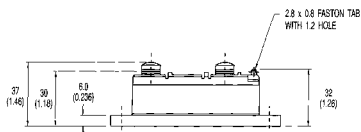
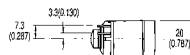
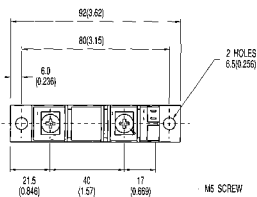
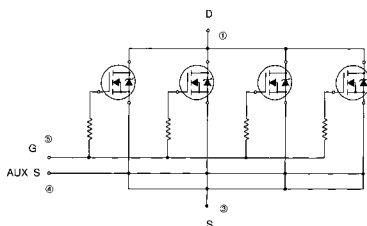


Fig 11b. Switching Time Waveforms



Circuit Configuration and Outline



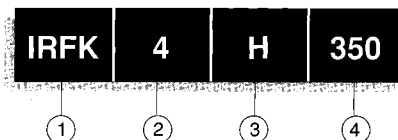
NOTE:
DEVICE IS SUPPLIED WITH
AUXILIARY LEADS 200(7.87) LONG

All dimensions in millimetres (inches)

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Part Numbering



1. - HEX-pak Module.
2. - Number of HEXFETs in parallel.
3. - H - Fast switching.
- J - Oscillation resistant for sensitive applications.
4. - Voltage code:-
054 - 60V
150 - 100V
250 - 200V
350 - 400V
450 - 500V
C50 - 600V

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In the interest of product improvement INTERNATIONAL RECTIFIER reserves the right to change specifications at any time without notice.

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